

SC020N65Y-R

Silicon Carbide MOSFET 650V, 20mΩ, 91A



重庆平伟半导体股份有限公司

Features

- Low switching losses
- Extremely low on-resistance $R_{DS(on)}$
- Robust body diode operation under hard commutation events
- Easy to Parallel and Simple to Drive
- Qualified according to JEDEC criteria

Applications

- Online UPS / Industrial UPS
- On-board charger
- DC/DC converter
- Auxiliary inverters

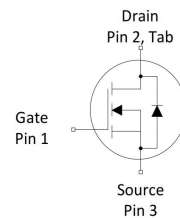
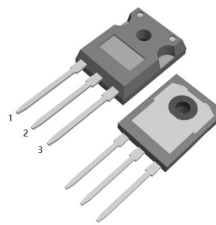


100% DVDS Tested
100% Avalanche Tested

Product Summary

V_{DS}	650V
$R_{DS(on)}$ typ.	20mΩ
I_D	91A

TO-247-3L



Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
SC020N65Y-R	SC020N65Y	TO-247-3L	Tube	N/A	N/A	30pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	650	V
Continuous drain current $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_D	91 64	A
Pulsed drain current ($T_C = 25^\circ\text{C}$)	$I_{D \text{ pulse}}$	272	A
Avalanche energy, single pulse ($L=5\text{mH}$)	E_{AS}	423	mJ
Gate-Source voltage, max. transient voltage	V_{GSmax}	-10/+22	V
Recommended operating values	V_{GSsop}	-5/+18	V
Power dissipation $T_C = 25^\circ\text{C}$	P_{tot}	222	W
Operating junction and storage temperature	T_j, T_{stg}	-55...+175	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Thermal resistance, junction – case.	R_{thJC}	-	0.45	0.68	°C/W	-
Thermal resistance, junction - ambient(min. footprint)	R_{thJA}	-	-	50.0	°C/W	-

Electrical Characteristic (at $T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

Static Characteristic

Drain-source breakdown voltage	BV_{DSS}	650	-	-	V	$V_{GS}=0V, I_D=100\mu A$
Gate threshold voltage	$V_{GS(th)}$	2.2	3.0	4.2	V	$V_{DS}=V_{GS}, I_D=10mA$
Zero gate voltage drain current	I_{DSS}	-	1	10	μA	$V_{DS}=650V, V_{GS}=0V$ $T_j=25^{\circ}C$ $T_j=175^{\circ}C$
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS}=22V, V_{DS}=0V$
		-	-	-100	nA	$V_{GS}=-13V, V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(on)}$	-	20	28	mΩ	$V_{GS}=18V, I_D=20A$
Transconductance	g_{fs}	-	10	-	S	$V_{DS}=18V, I_D=10A$

Dynamic Characteristic

Input Capacitance	C_{iss}	-	2977	-	pF	$V_{GS}=0V, V_{DS}=400V,$ $f=1MHz$
Output Capacitance	C_{oss}	-	186	-		
Reverse Transfer Capacitance	C_{rss}	-	9	-		
Gate Total Charge	Q_G	-	131	-	nC	$V_{DS}=400V, I_D=20A$ $V_{GS}=-5V/18V$
Gate-Source charge	Q_{gs}	-	49	-		
Gate-Drain charge	Q_{gd}	-	28	-		
Turn-on delay time	$t_{d(on)}$	-	15	-	ns	$V_{GS}=-5/18V,$ $V_{DD}=400V,$ $R_G=5\Omega, I_D=20A$
Rise time	t_r	-	45	-		
Turn-off delay time	$t_{d(off)}$	-	13	-		
Fall time	t_f	-	10	-		
Gate resistance	R_G	-	1.5	-	Ω	$V_{GS}=0V, f=1MHz$

Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	V_{SD}	-	3.4	-	V	$V_{GS} = -5V, I_{SD} = 20A$ $T_j = 25^{\circ}C$
		-	3.1	-		$T_j = 175^{\circ}C$
Body Diode Continuous Forward Current	I_S	-	-	86	A	$T_C = 25^{\circ}C$
		-	-	48	A	$T_C = 100^{\circ}C$
Body Diode Reverse Recovery Time	t_{rr}	-	17	-	ns	$V_{GS} = -5V, I_{SD} = 20A,$ $V_R = 400V$ $di/dt = 1200A/us$
Body Diode Reverse Recovery Charge	Q_{rr}	-	112	-	nC	
Peak Reverse Recovery Current	I_{RRM}	-	11	-	A	

Typical Performance Characteristics

Fig 1: Output Characteristics $T_j=25^\circ\text{C}$

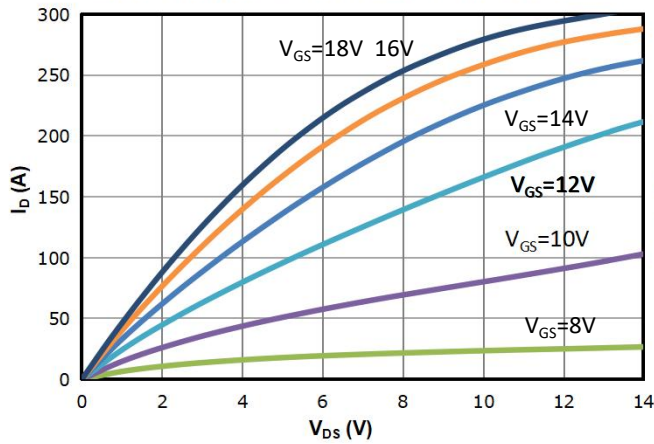


Fig 2: Output Characteristics $T_j=175^\circ\text{C}$

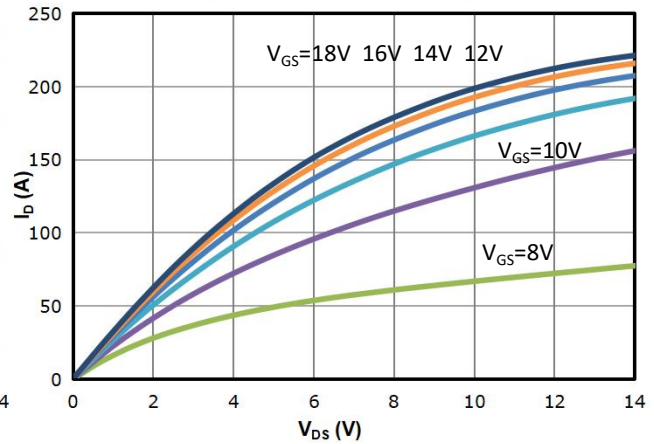


Fig 3: Transfer Characteristics

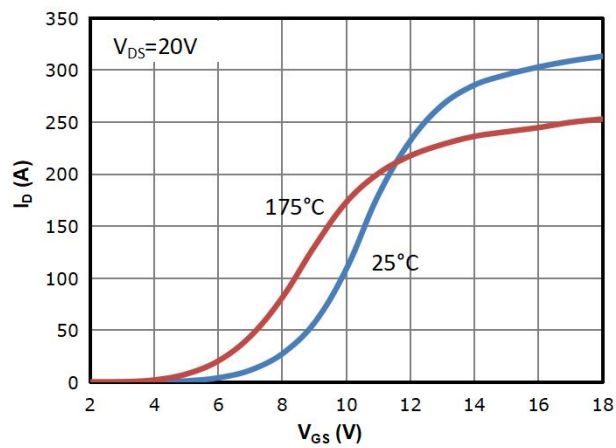


Fig 4: $R_{ds(on)}$ vs Drain Current and Gate Voltage

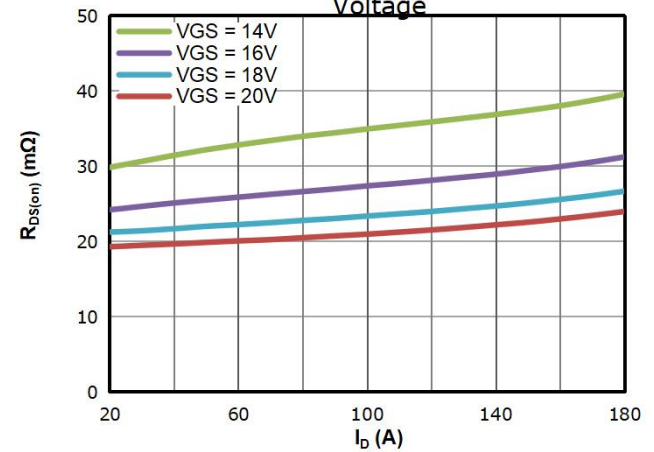


Fig 5: $R_{ds(on)}$ vs. Temperature

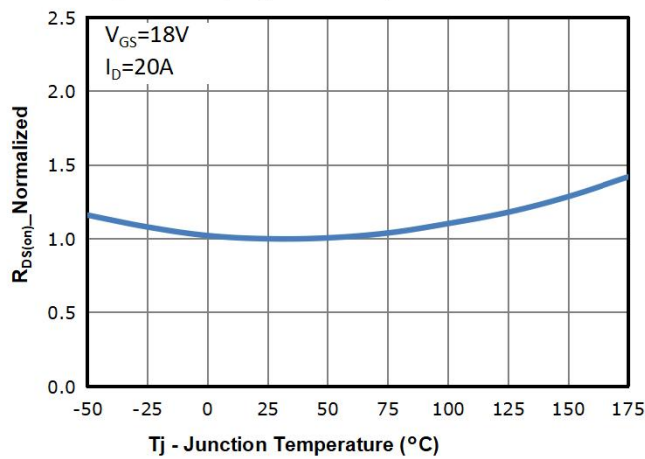


Fig 6: $V_{gs(th)}$ vs. Temperature

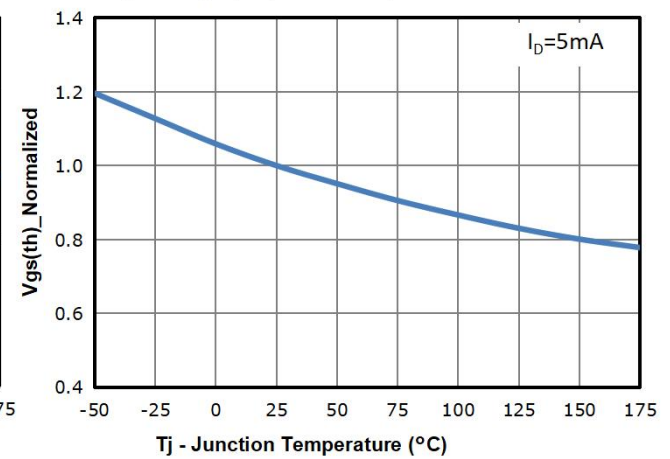


Fig 7: BVdss vs. Temperature

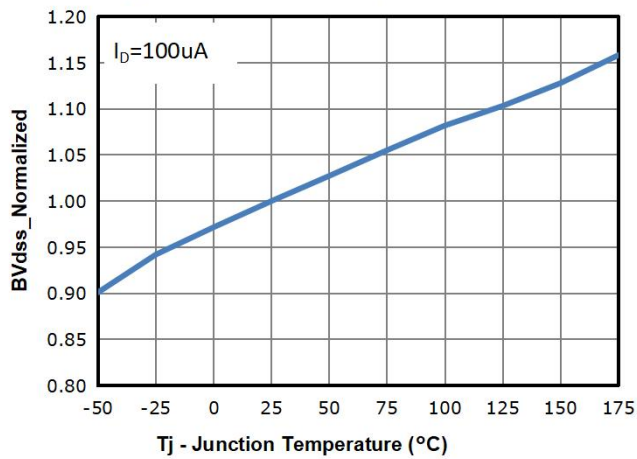


Fig 8: Capacitance Characteristics

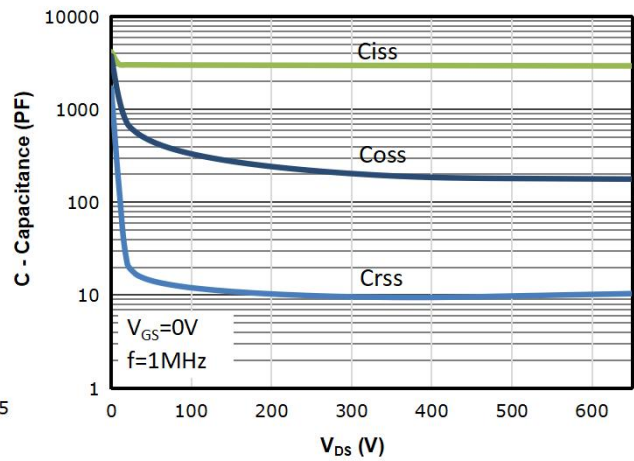


Fig 9: Gate Charge Characteristics

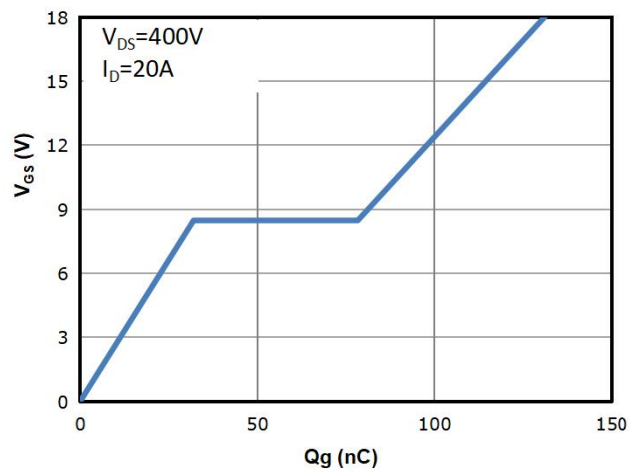


Fig 10: Body-diode Forward Characteristics

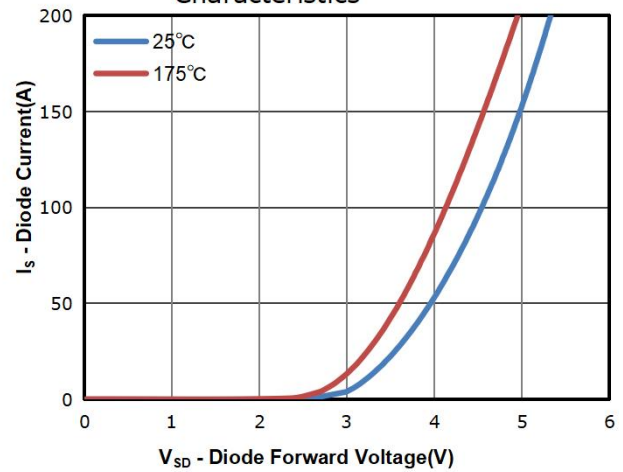


Fig 11: Power Dissipation

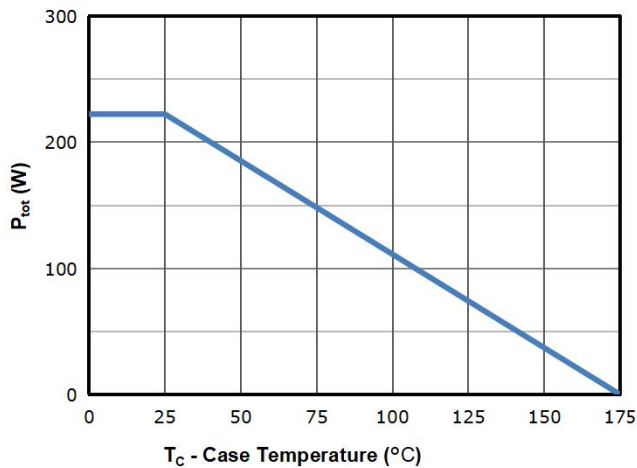


Fig 12: Drain Current Derating

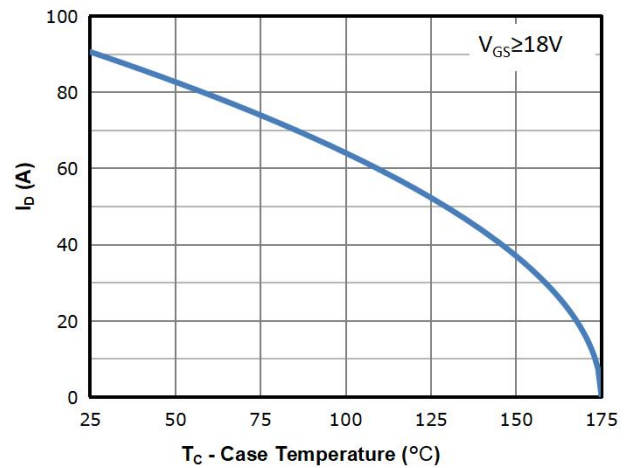


Fig 13: Safe Operating Area

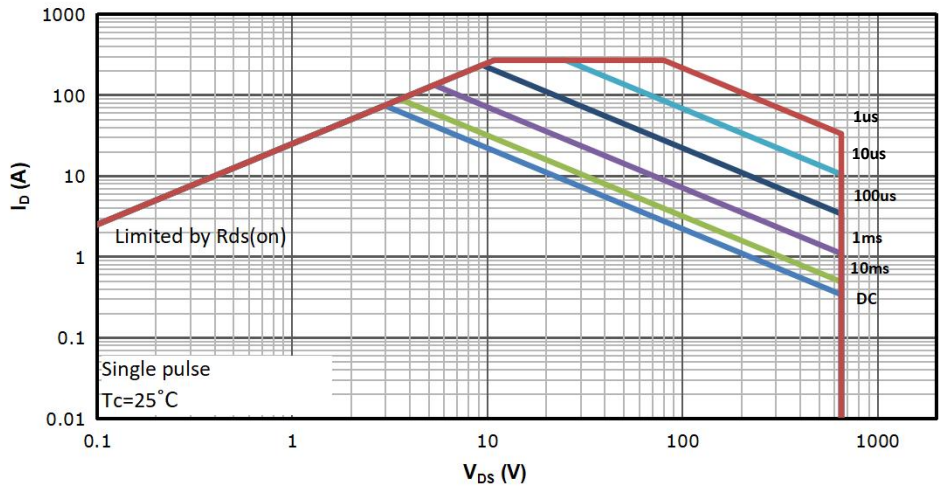
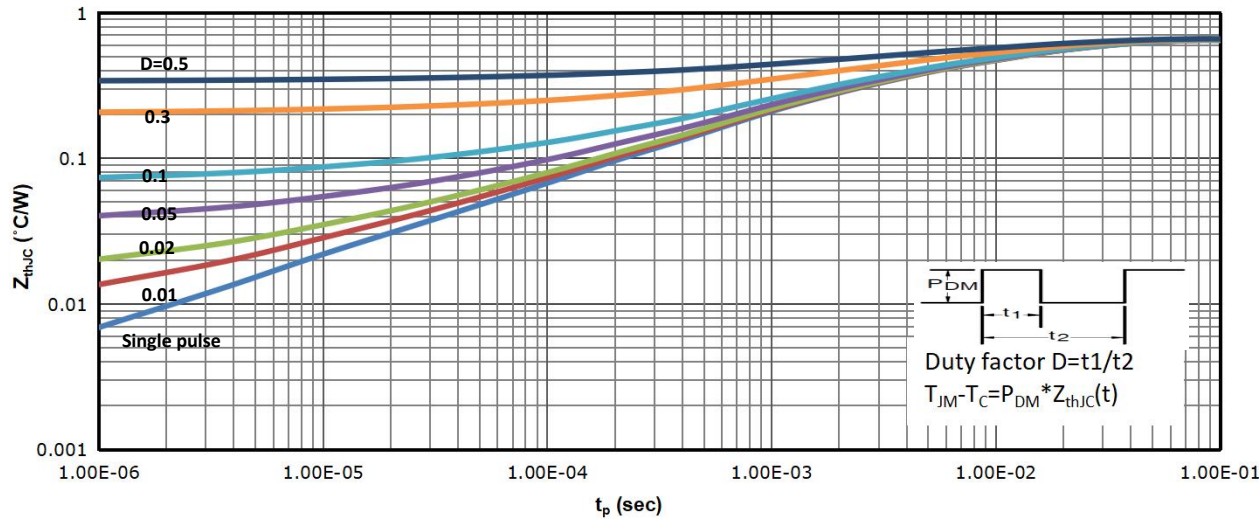
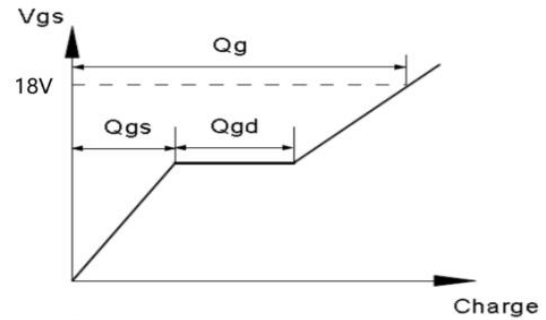
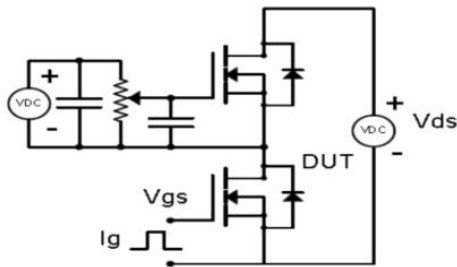


Fig 14: Max. Transient Thermal Impedance

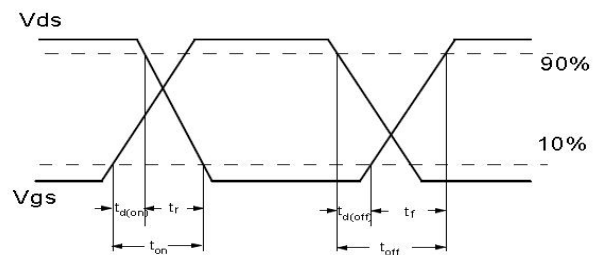
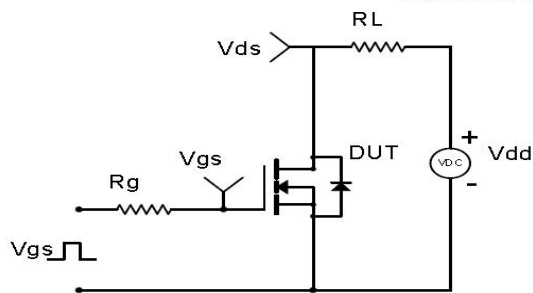


Test Circuit & Waveform

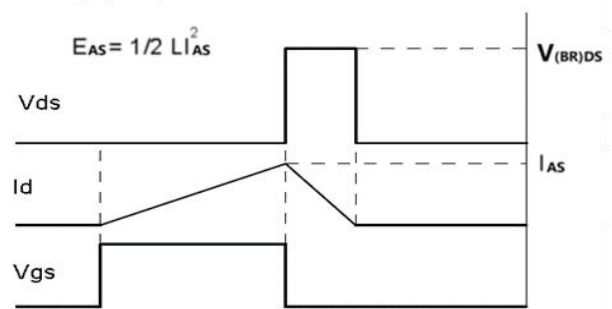
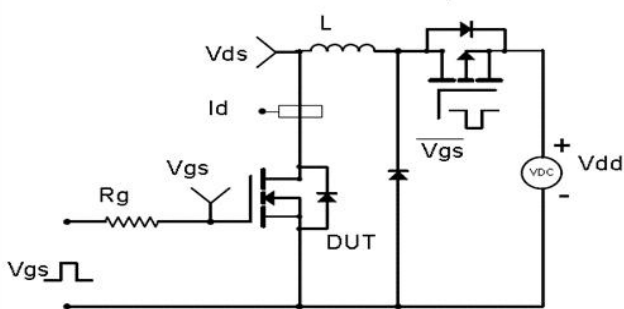
Gate Charge Test Circuit & Waveform



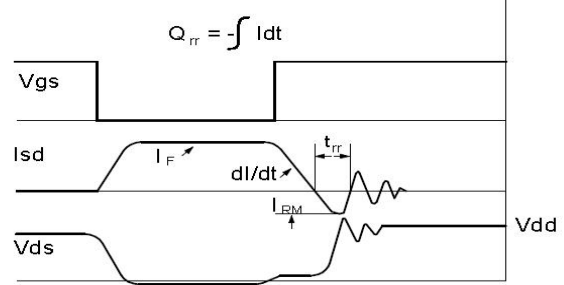
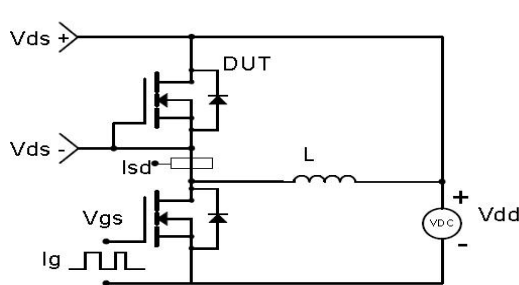
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



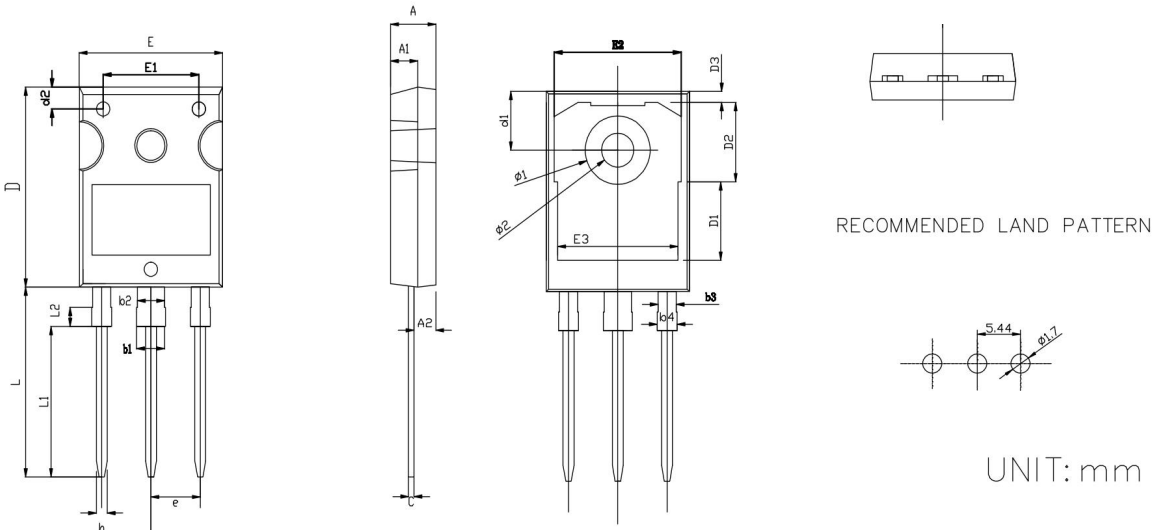
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Package Outline: TO-247-3L



SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.20	0.189	0.205
A1	2.80	3.20	0.110	0.126
A2	2.26	2.56	0.089	0.101
b	1.10	1.30	0.043	0.051
b1	2.90	3.20	0.114	0.126
b2	2.90	3.10	0.114	0.122
b3	1.90	2.10	0.075	0.083
b4	2.00	2.20	0.079	0.087
c	0.50	0.70	0.020	0.028
D	20.80	21.20	0.819	0.835
D1	8.23		0.324	
D2	8.32		0.328	
D3	1.17		0.046	
d1	6.00	6.30	0.236	0.248
d2	2.20	2.40	0.087	0.094
E	15.60	16.00	0.614	0.630
E1	10.50		0.413	
E2	14.02		0.552	
E3	13.50		0.531	
e	5.34	5.54	0.210	0.218
L	19.72	20.12	0.776	0.792
L1	15.79		0.622	
L2	1.98		0.078	
φ1	7.10	7.30	0.280	0.287
φ2	3.50	3.70	0.138	0.146

Disclaimer

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